



# Product Change Notification

**Change Notification #:** 116376 - 00  
**Change Title:** Intel® Post Brackets AXX2POSTBRCKT, PCN 116376-00, Transport Media, Update to Single Carton Box, Bulk Carton Box and Pallet design  
**Date of Publication:** July 19, 2018

## Key Characteristics of the Change:

Transport Media

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material*:</b>	August 3, 2018
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

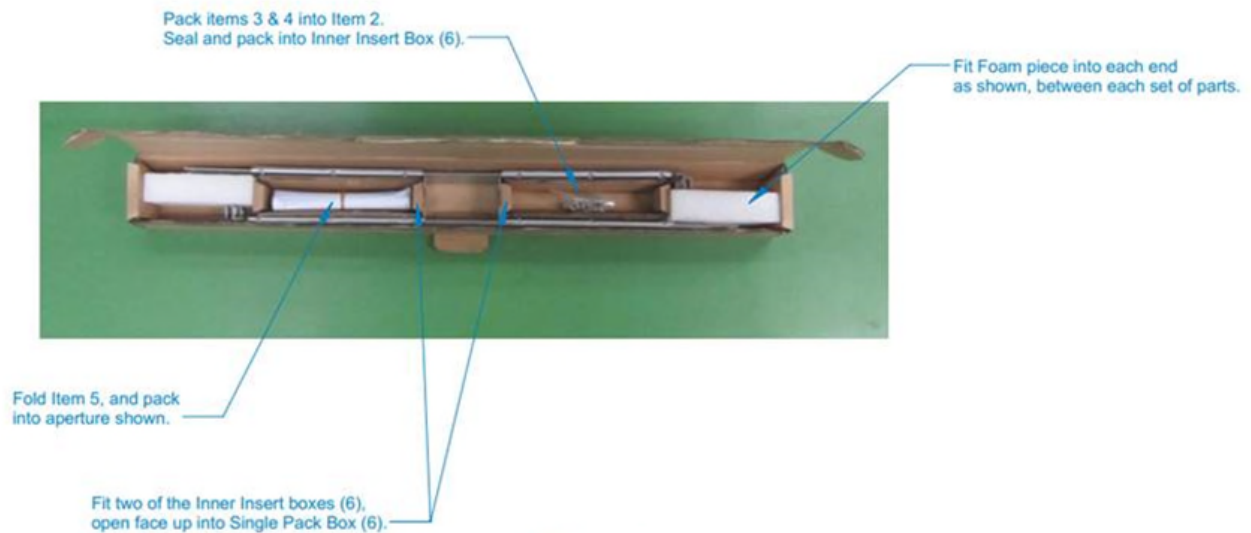
## Description of Change to the Customer:

Intel is enhancing the packaging used to ship the 1U/2U 2 post Brackets “AXX2POSTBRCKT” and changing the quantity of brackets shipped either on the bulk package and units per pallet.

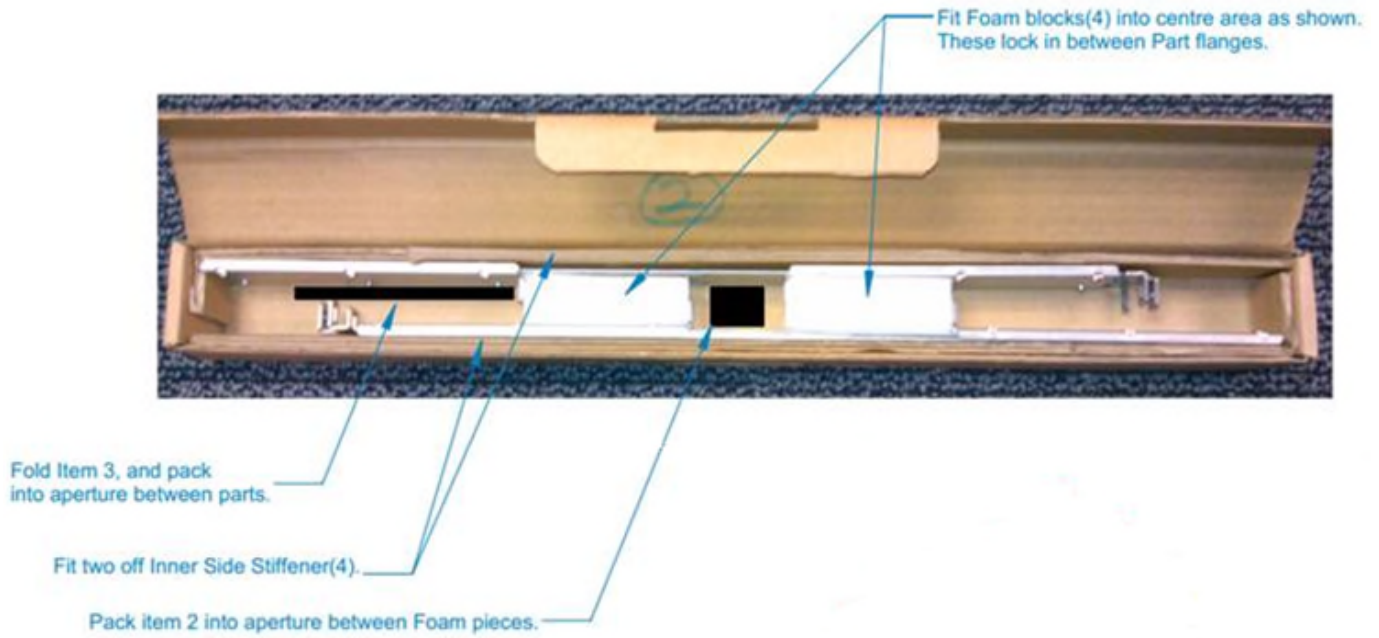
Description of changes:

1. Improved arrangement of foam and carton on each single box.
2. The quantity of brackets per bulk carton box change from 10 units to 8 units.
3. The quantity per pallet change from 210 units to 288 units.

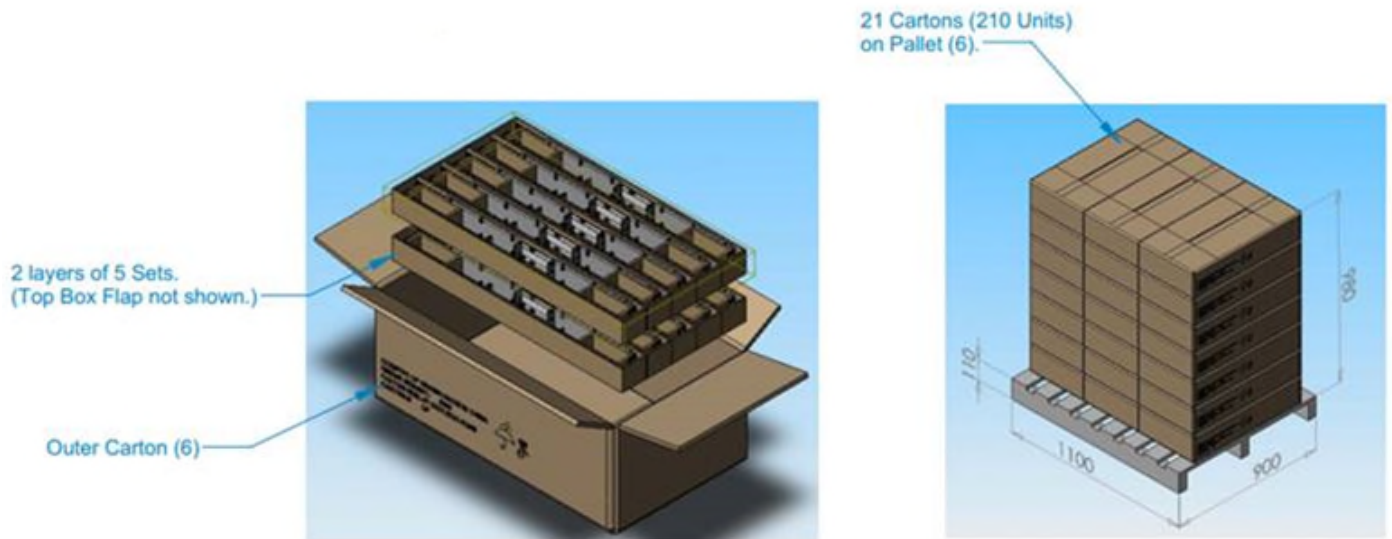
These changes rolls up TA number as shown in the “table products affected”.



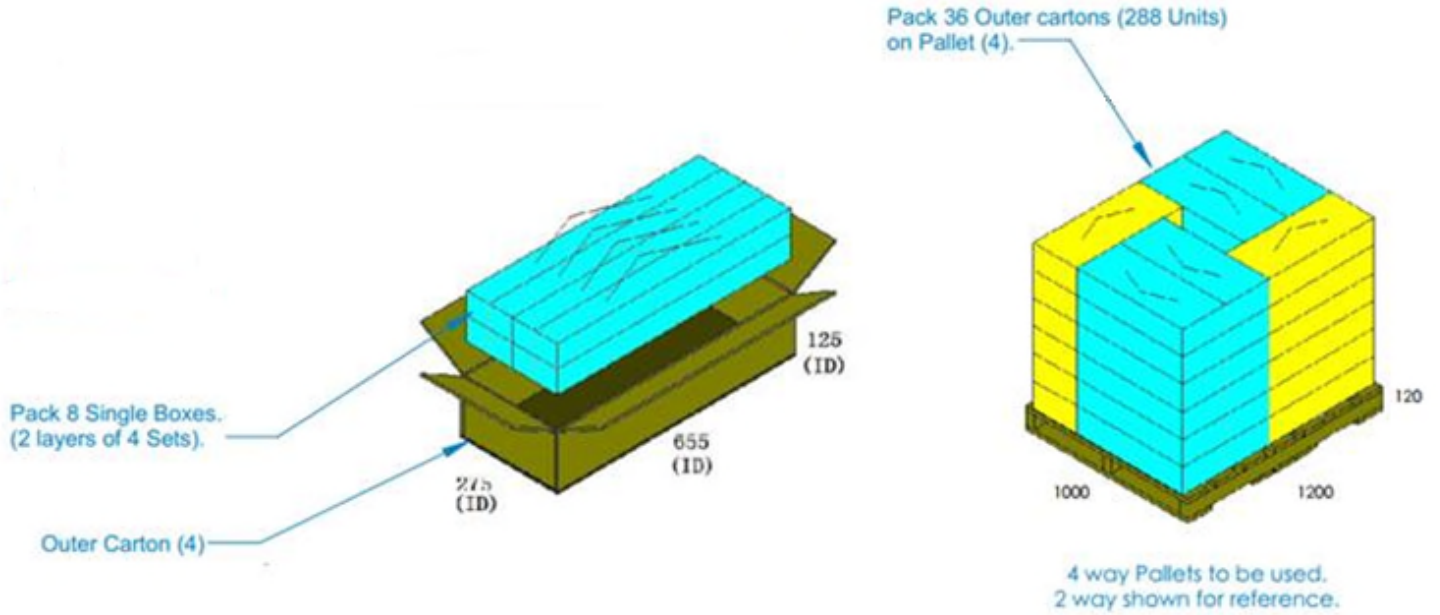
**Image 1.** Single carton box previous foam design



**Image 2.** Single carton box – New foam design



**Image 3.** Previous bulk carton box and pallet design



**Image 4.** New bulk carton box and pallet design

**Customer Impact of Change and Recommended Action:**

Intel does not expect any impact to customers from this change, but encourages customers to understand the modification and determine the impact on their applications. For that reason Intel recommends that the customer perform a standard level of evaluation.

**Products Affected / Intel Ordering Codes:**

Product Code	MM#	Pre Change TA	Post Change TA
AXX2POSTBRCKT	918808	G46228-001	G46228-002

**PCN Revision History:**

**Date of Revision:**  
July 19, 2018

**Revision Number:**  
00

**Reason:**  
Originally Published PCN



# Product Change Notification

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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